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74HC4538D,652

74HCT4538D,112

#### EN

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#### FR

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# 74HC4538; 74HCT4538

# Dual retriggerable precision monostable multivibrator Rev. 4 — 24 February 2016 Product de

Product data sheet

#### 1. **General description**

The 74HC4538; 74HCT4538 is a dual retriggerable-resettable monostable multivibrator. Each multivibrator has two trigger/retrigger inputs (nA and nB), a direct reset input (nCD), two complementary outputs (nQ and nQ), and two pins (nREXT/CEXT and nCEXT) for connecting the external timing components C<sub>EXT</sub> and R<sub>EXT</sub>. Typical pulse width variation over temperature range is ± 0.2%. The device may be triggered by either the positive or the negative edges of the input pulse. The duration and accuracy of the output pulse are determined by the external timing components C<sub>EXT</sub> and R<sub>EXT</sub>. The output pulse width (T) is equal to  $0.7 \times R_{EXT} \times C_{EXT}$ . The linear design techniques guarantee precise control of the output pulse width. A LOW level at nCD terminates the output pulse immediately. Schmitt-trigger action in the trigger inputs makes the circuit highly tolerant to slower rise and fall times. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V<sub>CC</sub>.

#### 2. **Features and benefits**

- Tolerant of slow trigger rise and fall times
- Separate reset inputs
- Triggering from falling or rising edge
- Complies with JEDEC standard no. 7A
- Input levels:
  - For 74HC4538: CMOS level
  - ◆ For 74HCT4538: TTL level
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

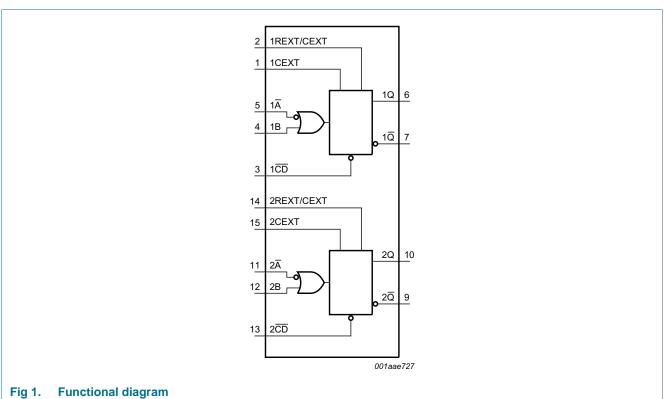


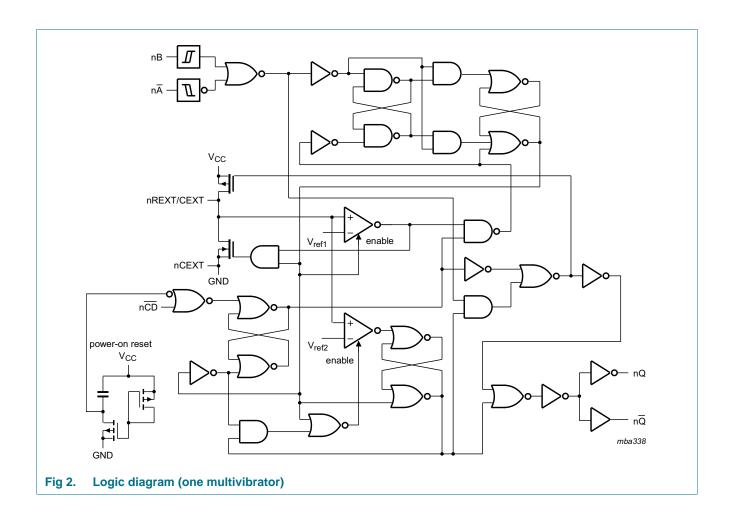
## **Ordering information**

Table 1. **Ordering information** 

Type number	Package			
	Temperature range	Name	Description	Version
74HC4538D	−40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74HCT4538D				
74HC4538DB	−40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads;	SOT338-1
74HCT4538DB			body width 5.3 mm	
74HC4538PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1
74HCT4538PW			body width 4.4 mm	

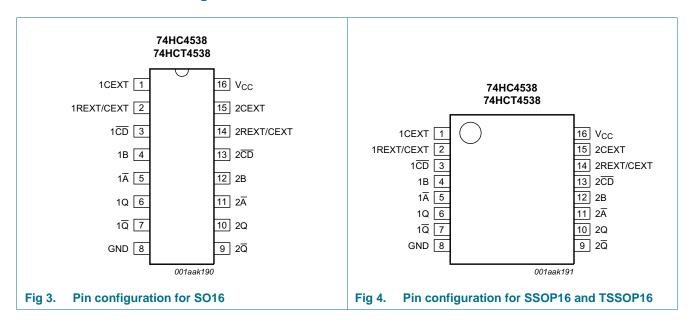
# **Functional diagram**





## 5. Pinning information

#### 5.1 Pinning



## 5.2 Pin description

Table 2. Pin description

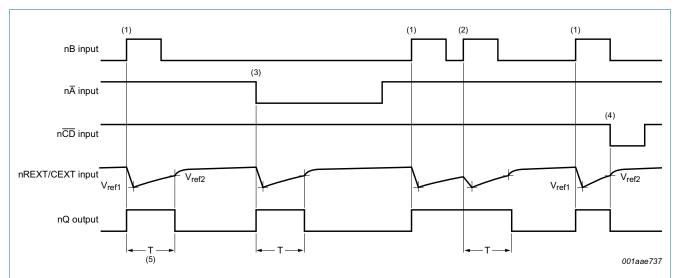
Symbol	Pin	Description
1CEXT, 2CEXT	1, 15	external capacitor connection (always connected to ground)
1REXT/CEXT, 2REXT/CEXT	2, 14	external capacitor/resistor connection
1CD, 2CD	3, 13	direct reset input (active LOW)
1B, 2B	4, 12	input (LOW to HIGH triggered)
1 <del>A</del> , 2 <del>A</del>	5, 11	input (HIGH to LOW triggered)
1Q, 2Q	6, 10	output
1Q, 2Q	7, 9	complementary output (active LOW)
GND	8	ground (0 V)
V <sub>CC</sub>	16	supply voltage

## 6. Functional description

Table 3. Function table

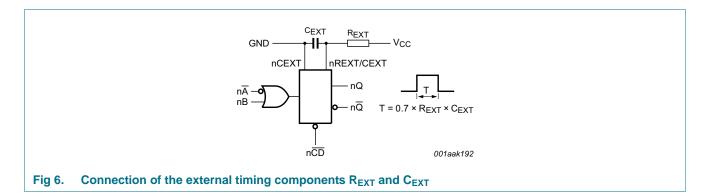
Inputs			Outputs			
nΑ	nB	nCD	nQ	nQ		
<b>\</b>	L	Н	Л	T		
Н	$\uparrow$	Н	Л	Т		
X	Х	L	L	Н		

- [1] H = HIGH voltage level; L = LOW voltage level; X = don't care;
  - $\uparrow$  = positive-going transition;  $\downarrow$  = negative-going transition;
  - $\square$  = one HIGH level output pulse, with the pule width determined by C<sub>EXT</sub> and R<sub>EXT</sub>;
  - $\Box$  = one LOW level output pulse, with the pulse width determined by  $C_{\text{EXT}}$  and  $R_{\text{EXT}}$ .



- (1) Positive edge triggering.
- (2) Positive edge re-triggering (pulse lengthening).
- (3) Negative edge triggering.
- (4) Reset (pulse shortening).
- (5)  $T = 0.7 \times R_{EXT} \times C_{EXT}$  (see also <u>Figure 6</u>).

Fig 5. Timing diagram



## 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{CC}$	supply voltage			-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	[1]	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$	[1]	-	±20	mA
Io	output current	$V_{O} = -0.5 \text{ V to } V_{CC} + 0.5 \text{ V}$		-	±25	mA
I <sub>CC</sub>	supply current			-	+50	mA
I <sub>GND</sub>	ground current			-50	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$				
		SO16 package	[2]	-	500	mW
		(T)SSOP16 package	[3]	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>[2]</sup> P<sub>tot</sub> derates linearly with 8 mW/K above 70 °C.

<sup>[3]</sup>  $P_{tot}$  derates linearly with 5.5 mW/K above 60 °C.

## 8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC4538		74	4HCT453	88	Unit	
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 \text{ V}$	-	-	83	-	-	-	ns/V

## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C t	-40 °C to +85 °C		-40 °C to +125 °C	
			Min	Тур	Max	Min	Max	Min	Max	
74HC45	38									
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		$V_{CC} = 6.0 \text{ V}$	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		$V_{CC} = 6.0 \text{ V}$	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$								
	output voltage	$I_{O} = -20 \mu A$ ; $V_{CC} = 2.0 \text{ V}$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -20 \mu A$ ; $V_{CC} = 4.5 \text{ V}$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -20 \mu A; V_{CC} = 6.0 \text{ V}$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$								
	output voltage	$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
		$I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1	-	±1	μΑ
		pin nREXT/CEXT; $V_I = 2.0 \text{ V or GND}$ ; other inputs at $V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V } \stackrel{[1]}{}$	-	-	±0.5	-	±5	-	±10	μА

74HC\_HCT4538

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 Table 6.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	-40 °C to	Unit	
			Min	Тур	Max	Min	Max	Min	Max	
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
C <sub>I</sub>	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT4	538									
$V_{IH}$	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
$V_{IL}$	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	$I_{O} = -20 \mu A$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -4.0 \text{ mA}$	3.98	4.32	-	3.84	-	3.7	-	V
$V_{OL}$	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1	-	±1	μΑ
		pin nREXT/CEXT; $V_I = 2.0 \text{ V or GND}$ ; other inputs at $V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V } \boxed{11}$	-	-	±0.5	-	±5	-	±10	μА
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
Δl <sub>CC</sub>	additional supply current	$\begin{split} V_I &= V_{CC} - 2.1 \text{ V; } I_O = 0 \text{ A;} \\ \text{other inputs at } V_{CC} \text{ or GND;} \\ V_{CC} &= 4.5 \text{ V to } 5.5 \text{ V} \end{split}$								
		pin nĀ, nB	-	50	180	-	225	-	245	μΑ
		pin nCD	-	65	234	-	293	-	319	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

<sup>[1]</sup> This measurement can only be carried out after a trigger pulse is applied.

## 10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
74HC453	38									
t <sub>PLH</sub>	LOW to HIGH propagation	nA, nB to nQ; see Figure 7								
	delay	V <sub>CC</sub> = 2.0 V	-	85	265	-	330	-	400	ns
		V <sub>CC</sub> = 4.5 V	-	31	53	-	66	-	80	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	27	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	25	45	-	56	-	68	ns
		nCD to nQ; see Figure 7								
		V <sub>CC</sub> = 2.0 V	-	83	265	-	340	-	400	ns
		V <sub>CC</sub> = 4.5 V	-	30	53	-	68	-	80	ns
		V <sub>CC</sub> = 6.0 V	-	24	45	-	58	-	68	ns
t <sub>PHL</sub>	HIGH to LOW propagation	nA, nB to nQ; see Figure 7								
	delay	V <sub>CC</sub> = 2.0 V	-	83	265	-	330	-	400	ns
		V <sub>CC</sub> = 4.5 V	-	30	53	-	66	-	80	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	27	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	24	45	-	56	-	68	ns
		nCD to nQ; see Figure 7								
		V <sub>CC</sub> = 2.0 V	-	80	265	-	330	-	400	ns
		V <sub>CC</sub> = 4.5 V	-	29	53	-	66	-	80	ns
		V <sub>CC</sub> = 6.0 V	-	23	45	-	56	-	68	ns
t <sub>t</sub>	transition time	nQ and $n\overline{Q}$ ; see Figure 7 [2]								
		V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	119	ns
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
t <sub>W</sub>	pulse width	nA LOW; see Figure 8								
		V <sub>CC</sub> = 2.0 V	80	17	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	6	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	5	-	17	-	20	-	ns
		nB HIGH; see Figure 8								
		V <sub>CC</sub> = 2.0 V	80	17	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	6	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	5	-	17	-	20	-	ns
		nCD LOW; see Figure 8								
		V <sub>CC</sub> = 2.0 V	80	19	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	7	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	6	-	17	-	20	-	ns
		nQ and nQ HIGH or LOW; see Figure 8								
		$V_{CC}$ = 5.0 V; $C_{EXT}$ = 0.1 μF; $R_{EXT}$ = 10 kΩ	630	700	770	602	798	595	805	μS
t <sub>rec</sub>	recovery time	nCD to nA, nB; see Figure 8								
		V <sub>CC</sub> = 2.0 V	35	6	-	45	-	55	-	ns
		V <sub>CC</sub> = 4.5 V	7	2	-	9	-	11	-	ns
		V <sub>CC</sub> = 6.0 V	6	2	-	8	-	9	-	ns
t <sub>rtrig</sub>	retrigger time	$\overline{NA}$ , nB; see Figure 8; $X = C_{EXT} / (4.5 \times V_{CC})$								
		V <sub>CC</sub> = 2.0 V	-	455 + X	-	-	-	-	-	ns
		V <sub>CC</sub> = 4.5 V	-	80 + X	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	55 + X	-	-	-	-	-	ns
R <sub>EXT</sub>	external timing	V <sub>CC</sub> = 2.0 V	10	-	1000	-	-	-	-	kΩ
	resistor	V <sub>CC</sub> = 5.0 V	2	-	1000	-	-	-	-	kΩ
C <sub>EXT</sub>	external timing capacitor				r	o limits		+		
C <sub>PD</sub>	power dissipation capacitance	per multivibrator; $V_I = GND \text{ to } V_{CC}$	-	136	-	-	-	-	-	pF

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
74HCT4	538									1
t <sub>PLH</sub>	LOW to HIGH propagation	nA, nB to nQ; see Figure 7								
	delay	V <sub>CC</sub> = 4.5 V	-	35	60	-	75	-	90	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	30	-	-	-	-	-	ns
		nCD to nQ; see Figure 7								
		V <sub>CC</sub> = 4.5 V	-	35	60	-	75	-	90	ns
t <sub>PHL</sub>	HIGH to LOW propagation	nA, nB to nQ; see Figure 7								
	delay	V <sub>CC</sub> = 4.5 V	-	35	60	-	75	-	90	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	30	-	-	-	-	-	ns
		nCD to nQ; see Figure 7								
		V <sub>CC</sub> = 4.5 V	-	35	60	-	75	-	90	ns
t <sub>t</sub>	transition time	nQ and nQ; see Figure 7 [2]								
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	21	ns
t <sub>W</sub>	pulse width	nA LOW; see Figure 8								
		V <sub>CC</sub> = 4.5 V	20	11	-	25	-	30	-	ns
		nB HIGH; see Figure 8								
		V <sub>CC</sub> = 4.5 V	16	5	-	20	-	24	-	ns
		nCD LOW; see Figure 8								
		V <sub>CC</sub> = 4.5 V	20	11	-	25	-	30	-	ns
		nQ and nQ HIGH or LOW; see <u>Figure 8</u>								
		$V_{CC}$ = 5.0 V; $C_{EXT}$ = 0.1 μF; $R_{EXT}$ = 10 kΩ	630	700	770	602	798	595	805	μS
t <sub>rec</sub>	recovery time	nCD to nA, nB; see Figure 8								
		V <sub>CC</sub> = 4.5 V	7	2	-	9	-	11	-	ns
t <sub>rtrig</sub>	retrigger time	$\overline{A}$ , nB; see Figure 8; $X = C_{EXT} / (4.5 \times V_{CC})$								
		V <sub>CC</sub> = 4.5 V	-	80 + X	-	-	-	-	-	ns
R <sub>EXT</sub>	external timing resistor	V <sub>CC</sub> = 5.0 V	2	-	1000	-	-	-	-	kΩ
C <sub>EXT</sub>	external timing capacitor	V <sub>CC</sub> = 5.0 V			r	o limits		1		

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

Symbol	Parameter	Conditions		25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
C <sub>PD</sub>	power dissipation capacitance	per multivibrator; $V_I = GND \text{ to } V_{CC} - 1.5 \text{ V}$	-	138	-	-	-	-	-	pF

- [1] Typical values are measured at nominal supply voltage ( $V_{CC} = 3.3 \text{ V}$  and  $V_{CC} = 5.0 \text{ V}$ ).
- [2]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .
- [3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i + \Sigma (C_L \times V_{CC}{}^2 \times f_o) + 0.48 \times C_{EXT} \times V_{CC}{}^2 \times f_o + D \times 0.8 \times V_{CC} \text{ where:}$ 

 $f_i$  = input frequency in MHz;

fo = output frequency in MHz;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs;

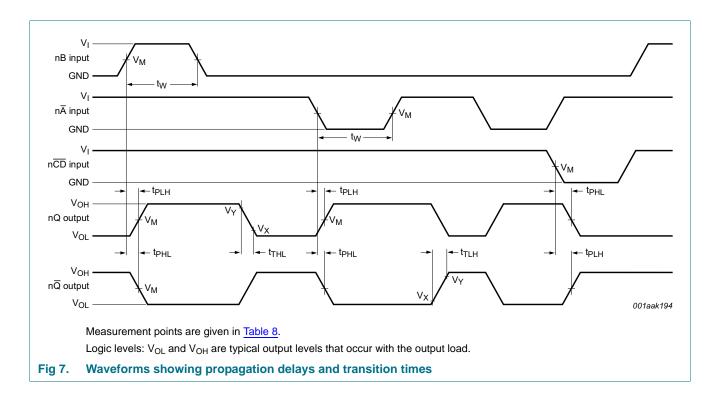
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

D = duty cycle factor in %;

C<sub>EXT</sub> = external timing capacitance in pF.

#### 11. Waveforms



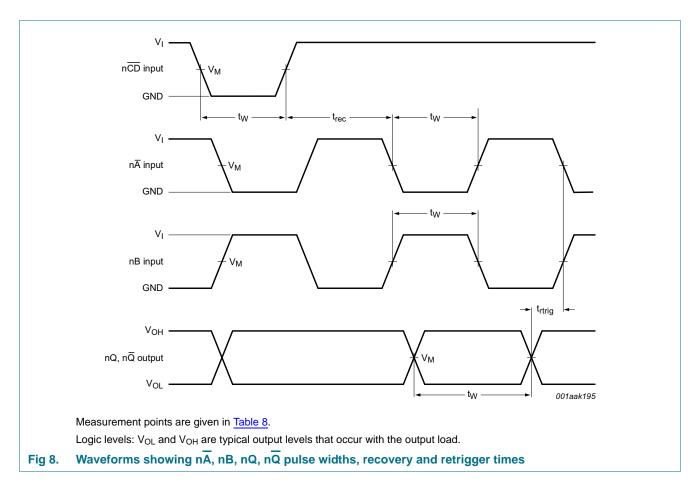
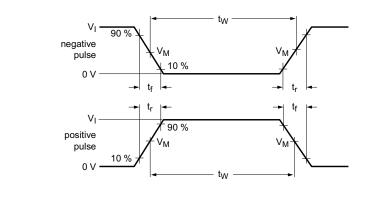
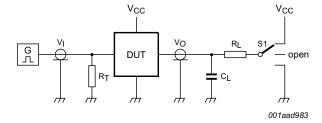


Table 8. Measurement points

Туре	Input	Output		
	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>
74HC4538	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>
74HCT4538	1.3 V	1.3 V	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>





Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

 $C_L$  = Load capacitance including jig and probe capacitance.

R<sub>L</sub> = Load resistance.

S1 = Test selection switch

Fig 9. Test circuit for measuring switching times

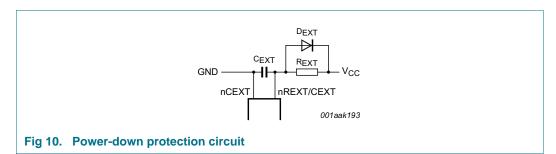
Table 9. Test data

Туре	Input		Load	S1 position	
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PHL</sub> , t <sub>PLH</sub>
74HC4538	V <sub>CC</sub>	6 ns	15 pF, 50 pF	1 kΩ	open
74HCT4538	3 V	6 ns	15 pF, 50 pF	1 kΩ	open

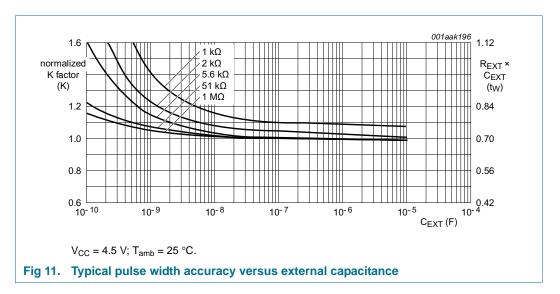
## 12. Application information

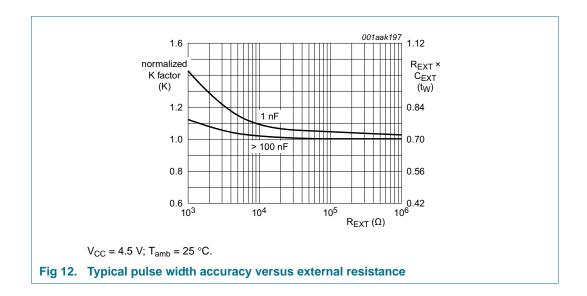
#### 12.1 Power-down considerations

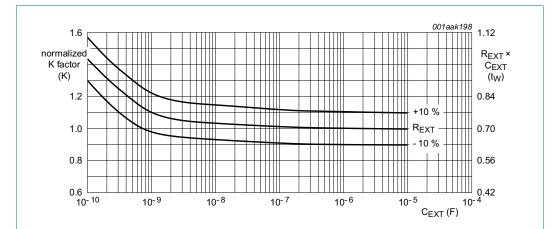
A large capacitor ( $C_{EXT}$ ) may cause problems when powering-down the monostable due to energy stored in this capacitor. When a system containing this device is powered-down or rapid decrease of  $V_{CC}$  to zero occurs, the monostable may sustain damage, due to the capacitor discharging through the input protection diodes. To avoid this possibility, use a damping diode ( $D_{EXT}$ ) preferably a germanium or Schottky type diode able to withstand large current surges and connect as shown in Figure 10

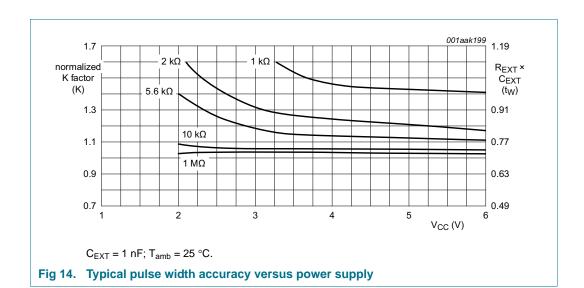


#### 12.2 Graphs



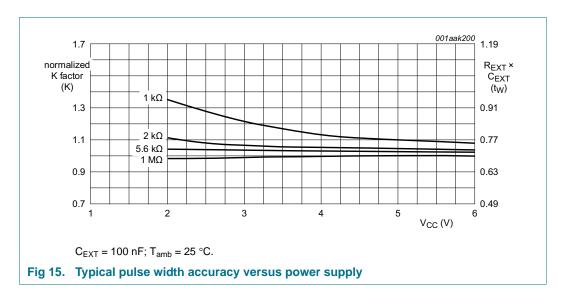


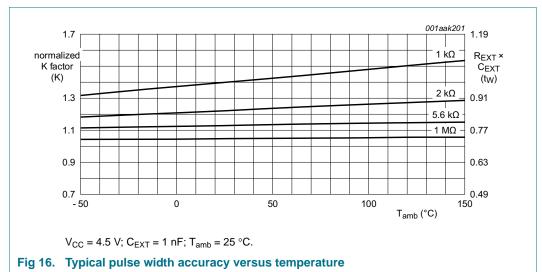


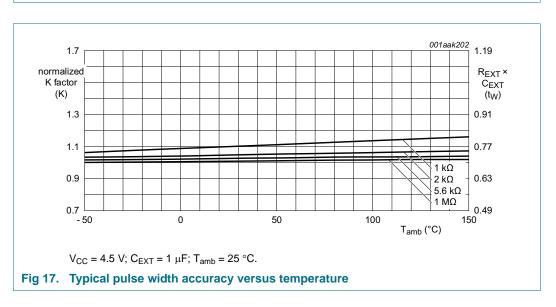


 $V_{CC}$  = 4.5 V;  $R_{EXT}$  = 10 kΩ;  $T_{amb}$  = 25 °C.

Fig 13. Typical pulse width accuracy versus external capacitance



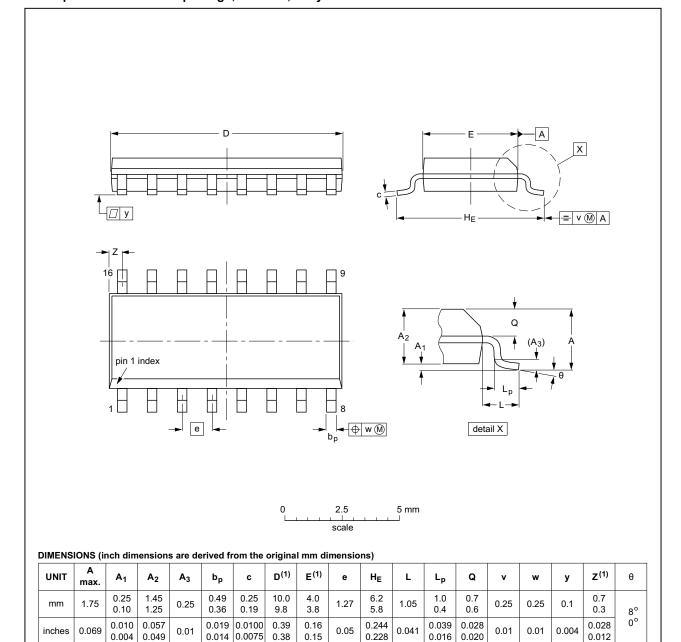




## 13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ICCUIT DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012			<del>99-12-27</del> 03-02-19	

Fig 18. Package outline SOT109-1 (SO16)

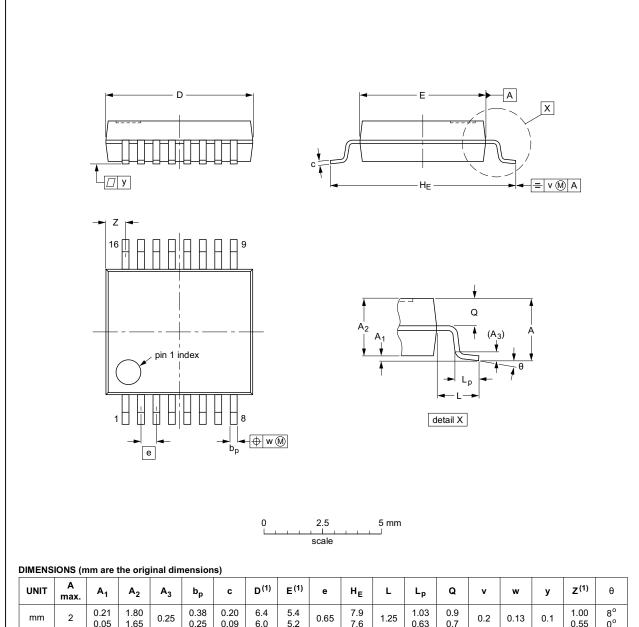
74HC\_HCT4538

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SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



						-,												
UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	IEC JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT338-1		MO-150			<del>99-12-27</del> 03-02-19	

Fig 19. Package outline SOT338-1 (SSOP16)

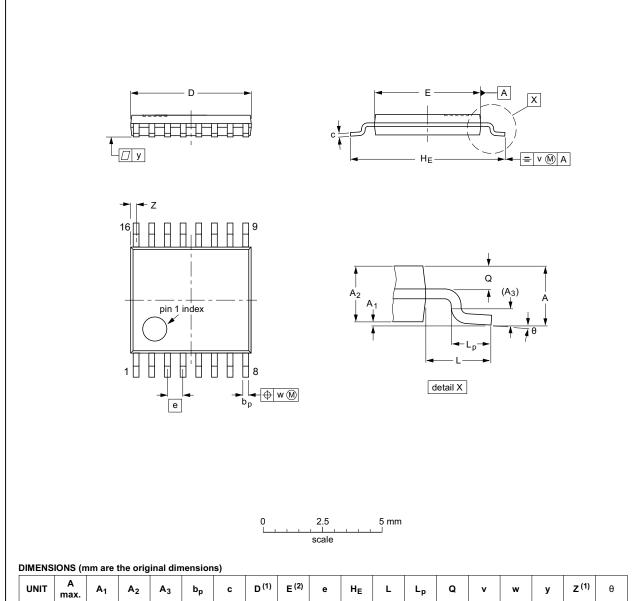
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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	<b>A</b> <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT403-1		MO-153			<del>99-12-27</del> 03-02-18

Fig 20. Package outline SOT403-1 (TSSOP16)

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## 14. Abbreviations

#### Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 15. Revision history

#### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74HC_HCT4538 v.4	20160224	Product data sheet	-	74HC_HCT4538 v.3			
Modifications:	Type numbers 74HC4538N and 74HCT4538N (SOT38-4) removed.						
74HC_HCT4538 v.3	20090608	Product data sheet	-	74HC_HCT4538_CNV v.2			
Modifications:	guidelines of l	this data sheet has been rede NXP Semiconductors.		·			
	<ul> <li>Legal texts ha</li> </ul>	ave been adapted to the new c	ompany name where	e appropriate.			
	<ul> <li>Pin names ch</li> </ul>	anged throughout.					
		on 7, Section 8 and Section 9 as/specification (March 1988).	added, taken from th	e 74HC/T HCMOS Family			
	<ul> <li>Test circuit ad</li> </ul>	lded: Figure 9.					
	<ul> <li>Quick referen</li> </ul>	ce data incorporated in to Sec	tion 9 and Section 1	<u>0</u> .			
	<ul> <li>Package information added for DIP16, SO16, SSOP16 and TSSOP16 packages.</li> </ul>						
74HC_HCT4538_CNV v.2	19970902	Product specification	-	-			

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Document status[1][2]	Product status[3]	Definition
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Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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